

SG Series









Agency Approvals

AGENCY	AGENCY FILE NUMBER
71 2	E128662

2 Electrode GDT Graphical Symbol



Description

Littelfuse SG series GDT offers high surge ratings in a miniature package. It's designed for surface mounting on PCB with small size 4.5x3.2x2.7mm. Low insertion loss is perfectly suited to broadband equipment applications. The capacitance does not vary with voltage, and will not cause operational problems with ADSL2+, where capacitance variation across Tip and Ring is undesirable. These devices are extremely robust and are able to divert a 1000A pulse without destruction.

Features

- RoHS compliant and Lead-free
- GHz working frequency
- Excellent stability on multiple pulse duty cycle
- Excellent response to fast rising transients.
- Ultra Low Insertion Loss
- 1-2KA surge capability tested with 8/20µS pulse as defined by IEC 61000-4-5
- Ultra small devices offered in a variety of mounting lead forms
- Non-Radioactive
- Low capacitance (<1pF)
- Voltage Ranges 75V to 600V
- UL recognized
- Conforms to ITU-T K12, IEC 1000-4-5
- Square Outline

Applications

- Communication equipment
- CATV equipment
- Test equipment
- Data lines
- Power supplies
- Telecom SLIC protection

- Broadband equipment
- ADSL equipment, including ADSL2+
- XDSL equipment
- Satellite and CATV equipment
- General telecom equipment

Gas Discharge Tube (GDT) Products SG Series

Electrical Characteristics Device Specifications (at 25°C) Life Ratings DC Breakdown Insulation Arc Impulse Impulse Glow Glow Nominal Nominal Nominal in Volts Breakdown Breakdown Resistance Voltage to Arc Voltage AC **Impulse** Impulse tance Discharge Discharge in Volts In Volts Transition Discharge (@1 Kv/µsec) Current Current Current Current Part (x10 @50Hz) x10 @8/20µs (10/1000µs Number MAX MIN TYP MAX MIN MAX SG75 52 75 98 500 650 SG90 90 117 500 600 2kA ~10 V ~1.0 A ~60 V SG150 105 150 195 500 600 2 A <1 pf SG230 172 230 288 650 800 SG300 225 375 700 850 ~12 V ~0.5 A ~90 V 300 >1GΩ SG300Q 210 300 390 580 650 ~20 V ~0.8 A ~140 V NA* (at 50VDC) SG350 263 350 437 750 900 ~90 V 2 A 10 A SG350Q 263 350 437 600 700 <0.8 pf ~12 V ~0.5 A ~140 V NA* ~90 V SG400 400 500 800 950 2 A 300 1kA 1000 ~10 V ~60 V 2 A SG420 315 420 525 800 NA* SG420Q 315 420 525 650 750 <1 pf ~20 V < 1.0 ASG450Q 370 450 550 680 750 ~20 V 1 A >1GΩ ~140 V SG500Q 600 950 1050 ~16 V 400 500 (at <0.5 pf ~0.1 A

<1 pf

~20 V

100VDC)

1200

1100

Product Characteristics

450

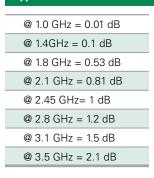
600

750

SG600Q

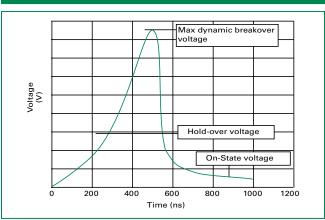
Materials	Device Tin Plated 17.5±12.5 Microns Construction Ceramic Insulator.
Storage and Operational Temperature	-40 to +90 °C

Typical Insertion Loss



Voltage vs. Time Characteristic

<0.5 A



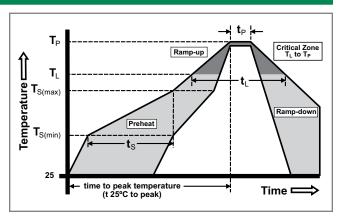
2 A

^{*} Specification is not applicable for quick response (SGxxxQ) version of product

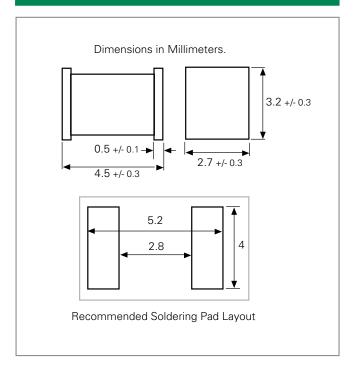


Soldering Parameters - Reflow Soldering (Surface Mount Devices)

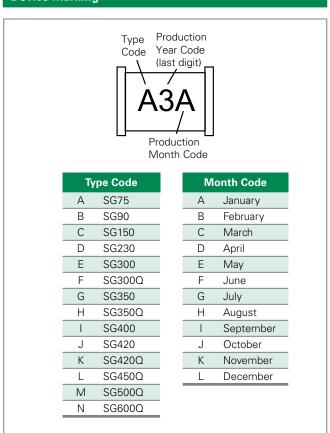
Reflow Condition		Pb – Free assembly
Pre Heat	-Temperature Min (T _{s(min)})	150°C
	-Temperature Max (T _{s(max)})	200°C
	-Time (Min to Max) (t _s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T _L) to peak		3°C/second max
T _{S(max)} to T _L - Ramp-up Rate		5°C/second max
Reflow	-Temperature (T _L) (Liquidus)	217°C
	-Temperature (t _L)	60 – 150 seconds
PeakTemperature (T _P)		260+0/-5 °C
Time within 5°C of actual peak Temperature (t _p)		10 – 30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peakTemperature (T _P)		8 minutes Max.
Do not exceed		260°C



Device Dimensions

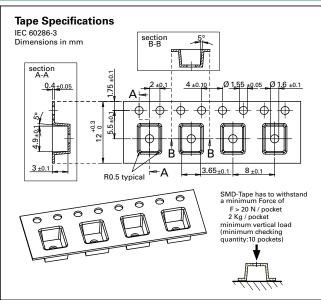


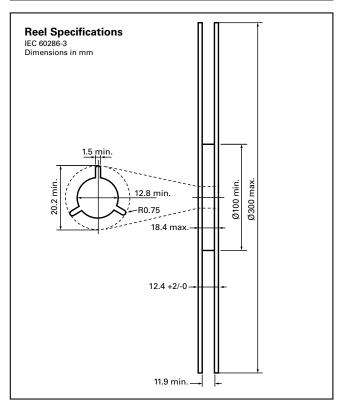
Device Marking



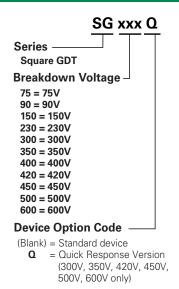


Tape and Reel Dimensions (IEC 60286-3, dimension in mm)





Part Numbering System and Ordering Information



Packaging					
Part Number and Device Type		Quantity and Packaging Description			
SGxxx	Surface mount	2000pcs/reel in tape and reel			